

# LED910-01

- Infrared LED
- 910 nm, 13 mW
- Chip: AlGaAs, 350 x 350 μm
- 5 mm Clear Molding, Epoxy Resin
- Viewing Angle: 18°

### Description



Rev 2.0, 30.04.2019



**LED910-01** contains one AlGaAs LED chip die mounted on a lead frame hermetically sealed with a clear epoxy lens.

On forward bias, it emits a power radiation of typical 13 mW at a peak wavelength at 910 nm.

### Maximum Ratings (T<sub>CASE</sub>=25°C)

Parameter	0	Va		
	Symbol	Min.	Max.	Unit
Power Dissipation	PD		160	mW
Forward Current	lF		100	mA
Pulse Forward Current *1	IFP		500	mA
Reverse Voltage	VF		5	V
Thermal Resistance	Rтнја		250	K/W
Junction Temperature	$T_J$		120	°C
Operating Temperature	TCASE	- 40	+ 100	°C
Storage Temperature	Tstg	- 40	+ 100	°C
Lead Solder Temperature *2	T <sub>SLD</sub>		+ 265	°C

\*1 duty=1%, pulse width = 10  $\mu$ s

\*2 must be completed within 3 seconds

# Electro-Optical Characteristics (TCASE=25°C)

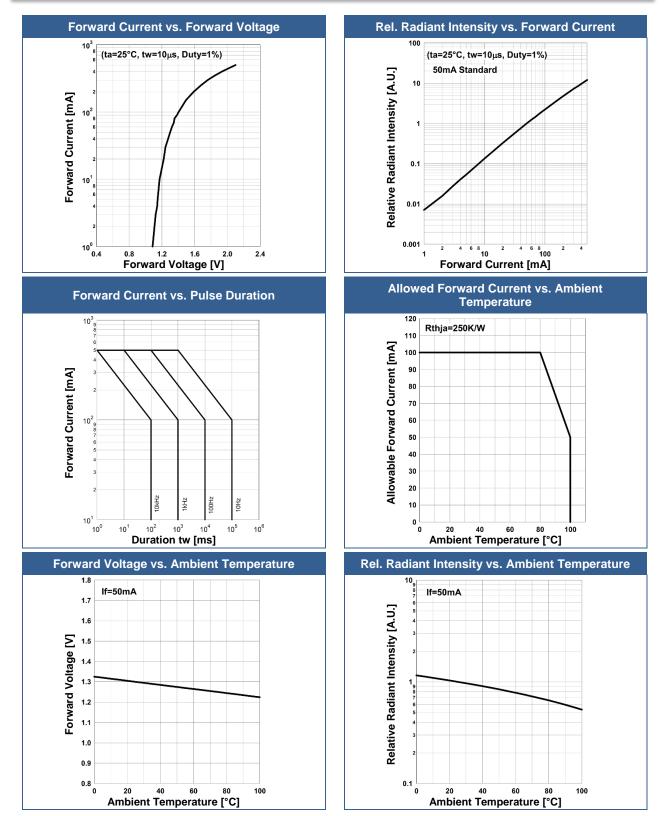
Parameter	Symbol	Conditions	Values			11
			Min.	Тур.	Max.	Unit
Peak Wavelength	$\lambda_P$	I⊧=50mA	895		925	nm
Half Width	$\Delta \lambda$	I⊧=50mA		46		nm
Forward Voltage	VF	I⊧=50mA		1.3	1.6	V
	VFP	IFP=500mA		2.1		
Radiated Power *1	Po	I⊧=50mA		13		mW
		IFP=500mA		150		
Radiant Intensity *2	IE	I⊧=50mA		75		mW/sr
		IFP=500mA		900		
Viewing Angle	φ	I⊧=50mA		18		deg.
Rise Time	t <sub>R</sub>	I⊧=50mA		30		ns
Fall Time	t <sub>F</sub>	I⊧=50mA		40		ns

\*1 measured by S3584-08

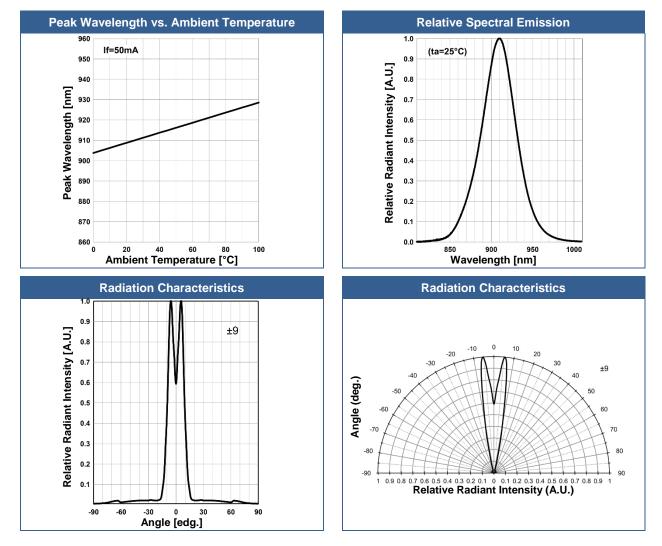
\*2 measured by CIE127-2007 Condition B



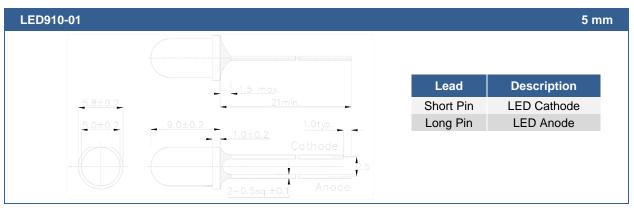
# Typical Performance Curves







# **Outline Dimensions**



All Dimensions in mm

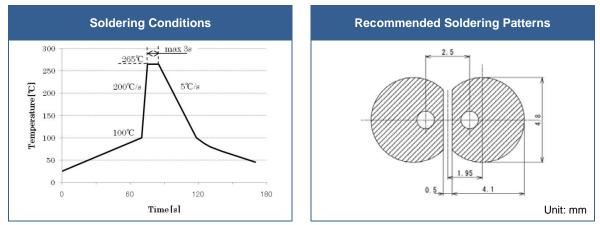


### Precautions

#### Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering
- Do not solder the LED closer than 3 mm from the base of the lead.

#### **Recommended soldering conditions:**



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

#### Cleaning:

#### Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

#### Static Electricity:

**LEDs are sensitive to electrostatic discharge (ESD)**. Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

#### **Radiation:**

During operation these LEDs do emit light, which could be hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. Protective glasses if needed. It is further advised to attach a warning label on products/systems.

#### **Operation:**

#### Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

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The above specifications are for reference purpose only and subjected to change without prior notice